



DS

TO THE ASSISTANT COMMISSIONER FOR I

103506033

documents or copy thereof.

1. Name of conveying party(ies): (If multiple assignors, list numerically)

(1) Masakatsu Tsuda

Additional name(s) of conveying party(ies) attached?
() Yes (X) No

2. Name and address of receiving party(ies):

Name: Advantest Corporation

Address: 32-1, Asahicho 1-chome, Nerima-ku,
Tokyo, 179-0071 JapanAdditional name(s) of receiving party(ies) attached?
() Yes (X) No

3. Nature of conveyance:

- (X) Assignment
() Merger
() Security Agreement
() Change of Name
() Other:

Execution Date: (If multiple assignors, list execution dates in numerical order corresponding to numbers indicated in 1 above)

January 30, 2008

4. Application number(s) or Patent number(s):

() Application(s) No.: 11/989,713
Filing Date: January 29, 2008() International Application No.:
International Filing Date:() Patent No.:
Issue Date:

Additional numbers attached? () Yes (X) No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Yasuo Muramatsu
MURAMATSU & ASSOCIATES

Internal Address: Suite 310

Street Address: 114 Pacifica

City: Irvine State: CA ZIP: 92618

Attorney's Docket No.: HEIWA.038AUS

7. Total fee (37 CFR 3.41): \$40.00

- (X) Enclosed
() Authorized to be charged to deposit account

8. Deposit account number:

Please charge this account for any additional fees which may be required, or credit any overpayment to this account.

6. Total number of applications and patents involved: 1

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

Yasuo Muramatsu
Name of Person Signing
Signature5/20/08
Date38,684
Registration No.

Total number of pages including cover sheet, attachments and document: 2

Mail documents to be recorded with required cover sheet information to:

Assistant Commissioner for Patents 05/30/2008 MJAMA1 00000002 11983713
Box Assignments 01 FC:8021 40.00 OP
Alexandria, VA 22313-1450

Application No.:
Filing Date:

PATENT
Client Code: HEIWA.0384us
Page 1

ASSIGNMENT

WHEREAS, I, **Masakatsu SUDA**, a citizen of Japan, a resident of 32-1, Asahicho 1-chome, Nerima-ku, Tokyo 179-0071 Japan, have invented certain new and useful improvements in

TIMING GENERATOR AND SEMICONDUCTOR TEST APPARATUS

for which an International application for a letter of patent was filed on July 28, 2006 with International Application No. **PCT/JP2006/314953** and an application for entering the national stage of the United States of America under 35 U.S.C. 371 (c) is filed concurrently herewith;

AND WHEREAS, **Advantest Corporation** (hereinafter "ASSIGNEE"), a Japanese corporation, with its principal place of business at 32-1, Asahicho 1-chome, Nerima-ku, Tokyo 179-0071 Japan, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in the receipt of valuable consideration which is hereby acknowledged, I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and I do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

This 30 day of Jan. 2008

Masakatsu Suda
Masakatsu SUDA